Texas Instruments
SAT0103-E1

Components marked 'DNP' should not be populated.
Assembly variant: 001

PCB viewed from top side
Board #: SAT0103
Rev: E1
Sun Rev: Not In Version Control

Ignore -> Top Overlay
Plot name = Top Assembly Drawing
Generated: 7/14/2014 4:17:18 PM
Texas Instruments
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: SAT0103</th>
<th>REV: E1</th>
<th>SUN REV: Not In VersionControl</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td>IGNORE -&gt;</td>
</tr>
<tr>
<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 7/14/2014 4:17:19 PM</td>
<td>TEXAS INSTRUMENTS</td>
<td></td>
</tr>
</tbody>
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Legend:
- H5
- H6
- H8
- U1
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